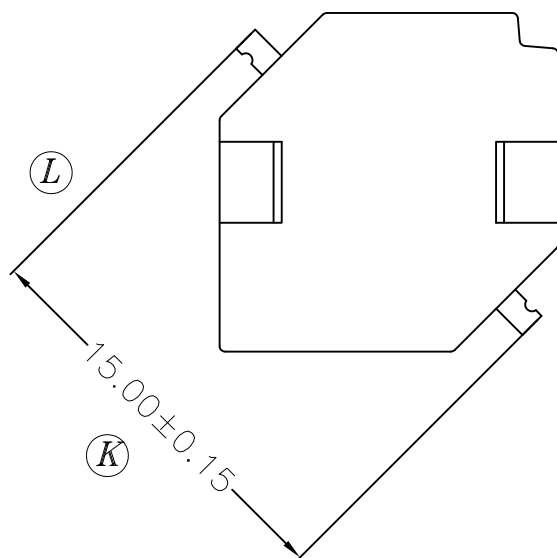
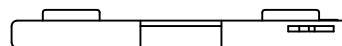
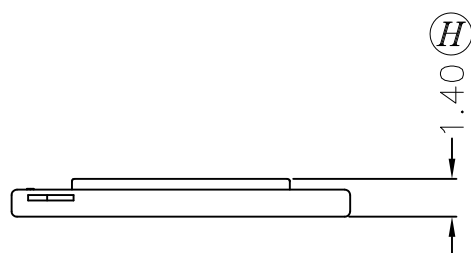
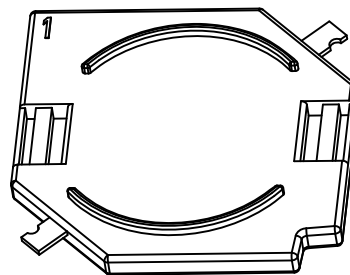
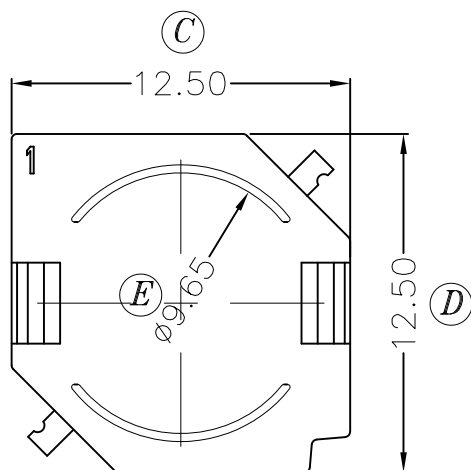
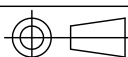


技术要求:
端子部分电镀雾锡 镍底 $2\sim 4\mu\text{m}$ 锡 $6\sim 10\mu\text{m}$

REV.	REVISIONS	REC.	DATE	REV.	REVISIONS	REC.	DATE
0	初版发行		DEC 18'13				
1	E尺寸9.60更改为9.65,F尺寸10.20更改为10.25.						

DRAWN & DRAFTED BY	Kuang Honghua	TOLERANCES		ANGLE:	TITLE:		
CHECKED & APPROVED BY	BEN LEE	0<L≤4 ±0.1	COPLANARITY 0.1mm MAX	UNIT:	SMD BASE DR9.6		
		4<L≤16 ±0.2		PLASTIC MATERIAL:	UL REC.		
		16<L≤63 ±0.3		Sumitomo PM 9630JT	UL 94V-0		
 广州市申拓电子有限公司 SMD-TOP ELECTRONIC (GZ) CO.,LTD. TEL:020-84842698 FAX:020-84842398				ORIGIN:	METAL MATERIAL:	PIN TENSION LOAD:	
				GZ	C1100 H	1.0Kg	
					DATE:	DRAWING NO.	REV.
				DEC 18'2013	ST-BS025.01	1	